



N and P-Channel Enhancement Mode Power MOSFET

Description

The NCE603S uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge . The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

General Features

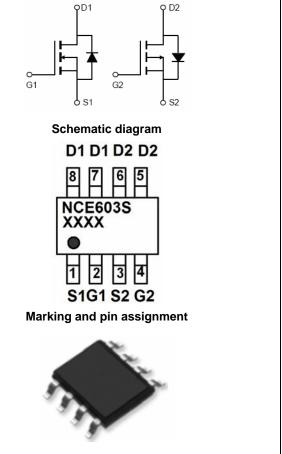
N-Channel

 $V_{DS} = 60V, I_D = 6.3A$ $R_{DS(ON)} < 30m\Omega @ V_{GS} = 10V$

P-Channel

 $V_{DS} = -60V, I_D = -6A$ $R_{DS(ON)} < 80m\Omega @ V_{GS} = -10V$

- High power and current handing capability
- Lead free product is acquired
- Surface mount package



SOP-8 top view

Package Marking and Ordering Information

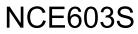
NCE603S NCE603S SOP-8 Ø330mm 12mm 2500 ur	units

Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Parameter		Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage Gate-Source Voltage		V _{DS}	60	-60	V	
		V _{GS}	±20	±20	V	
Continuous Drain Current	T _A =25℃		6.3	-6	А	
	T _A =100℃	ID ID	4.5	-4.2		
Pulsed Drain Current (Note 1)		I _{DM}	40	-25	А	
Maximum Power Dissipation	T _A =25℃	PD	2.0	2.0	W	
Operating Junction and Storage Temperature Range		TJ,TSTG	-55 To 150	-55 To 150	°C	
Thermal Characteristic						
Thormal Registeres Junction to	Р	N Ch	62.5	°C ///		

Thermal Resistance, Junction-to-Ambient (Note2)	$R_{ extsf{ heta}JA}$	N-Ch	62.5	°C/W
Thermal Resistance, Junction-to-Ambient (Note2)	$R_{ extsf{ heta}JA}$	P-Ch	62.5	°C/W

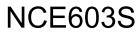




N-CH Electrical Characteristics (T_A=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	purce Breakdown Voltage BV _{DSS} V _{GS} =0V I _D =250µA		60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	· · ·			•		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.2	1.6	2.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =10V, I _D =6A	-	26	30	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =6A	15	-	-	S
Dynamic Characteristics (Note4)	· · ·					
Input Capacitance	C _{lss}	V _{DS} =15V.V _{GS} =0V.	-	500	-	PF
Output Capacitance	C _{oss}	v _{DS} =13v,v _{GS} =0v, F=1.0MHz	-	60	-	PF
Reverse Transfer Capacitance	C _{rss}		-	25	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	5	-	nS
Turn-on Rise Time	tr	V_{DD} =30V, R _L =4.7 Ω	-	2.6	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =3 Ω	-	16.1	-	nS
Turn-Off Fall Time	t _f		-	2.3	-	nS
Total Gate Charge	Qg		-	25	-	nC
Gate-Source Charge	Q _{gs}	$V_{DS} = 15V, I_D = 6A,$	-	4.5	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	6.5	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =6A	-	0.8	1.2	V





P-CH Electrical Characteristics (T_A=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	· ·		•			•
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-1.5	-2.6	-3.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-5A	-	64	80	mΩ
Forward Transconductance	G FS	V _{DS} =-15V,I _D =-5A	16	-	-	S
Dynamic Characteristics (Note4)			L			
Input Capacitance	Clss)/ - 20)/// -0)/	-	1450	-	PF
Output Capacitance	Coss	V _{DS} =-20V,V _{GS} =0V, F=1.0MHz	-	145	-	PF
Reverse Transfer Capacitance	C _{rss}		-	110	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	8	-	nS
Turn-on Rise Time	tr	V_{DD} =-30V, ,R _L =30 Ω	-	9	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10V, R_{GEN} =6 Ω	-	65	-	nS
Turn-Off Fall Time	t _f		-	30	-	nS
Total Gate Charge	Qg		-	26	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =-30V,I _D =-5A,	-	4.5	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	7	_	nC
Drain-Source Diode Characteristics	· ·		•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-6A	-	-	-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-6	А

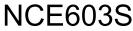
Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production





125

30

25°C

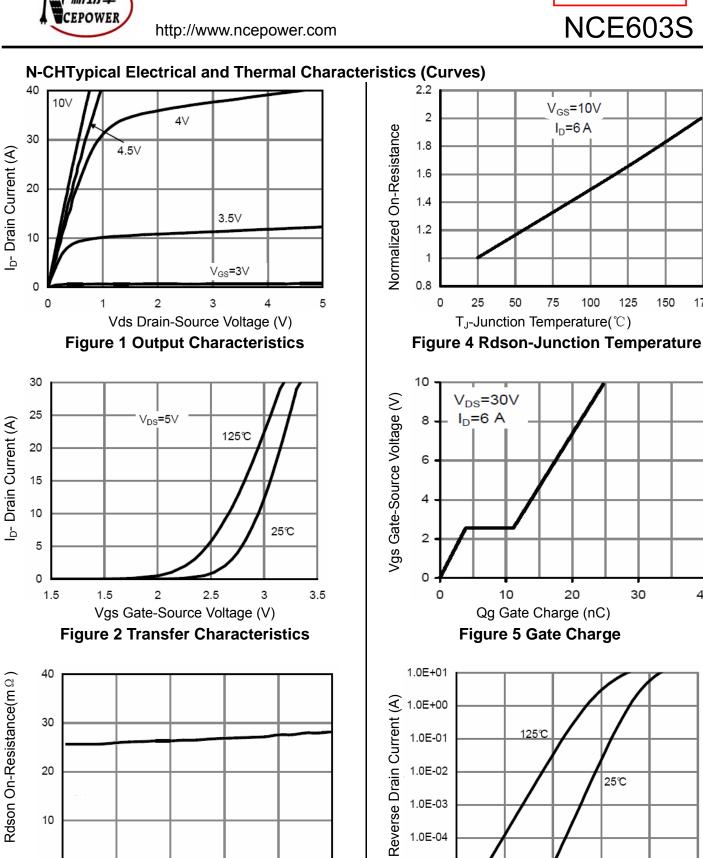
0.6

0.8

150

175

40



5

10

I_D- Drain Current (A)

Figure 3 Rdson- Drain Current

20

10

0

0

20

25

15

1.0E-02

1.0E-03

1.0E-04

0.0

0.2

0.4

Vsd Source-Drain Voltage (V) Figure 6 Source- Drain Diode Forward

1.0



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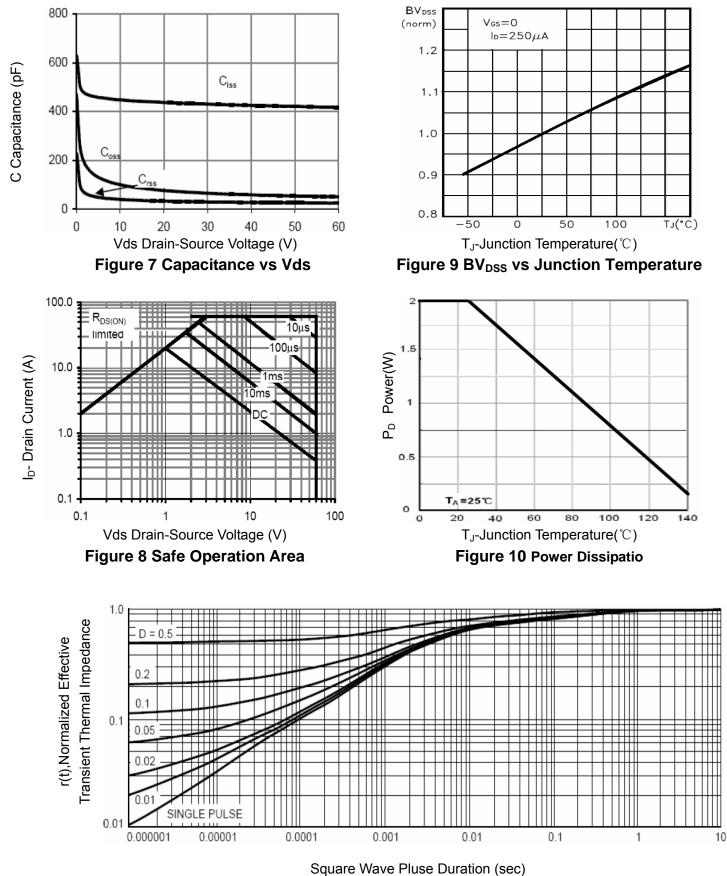
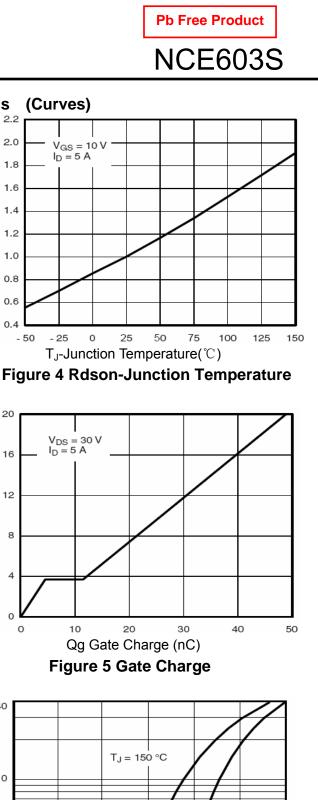


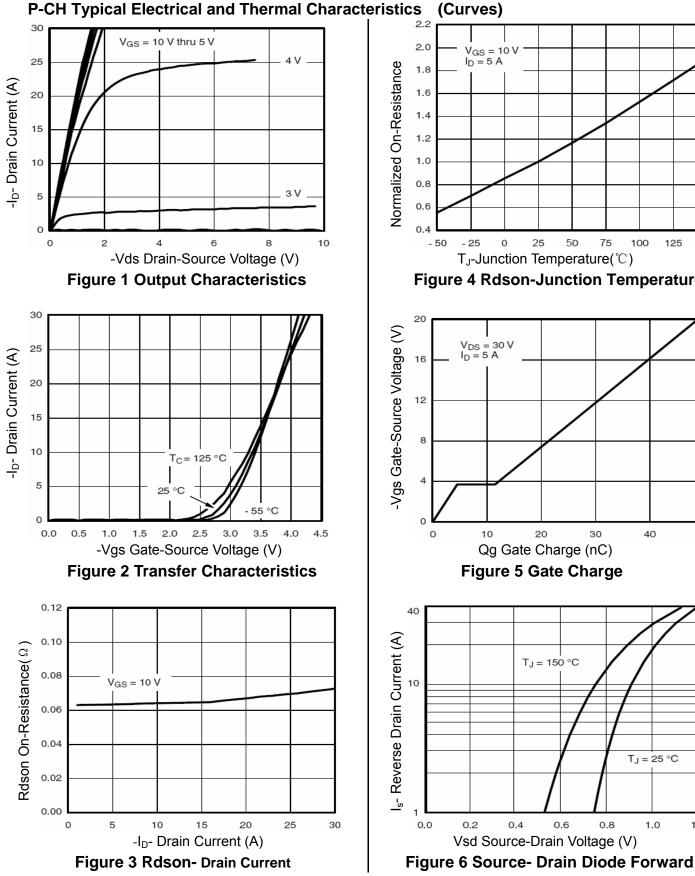
Figure 11 Normalized Maximum Transient Thermal Impedance



POWE

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1.2

T」= 25 ℃

1.0

0.4

0.6

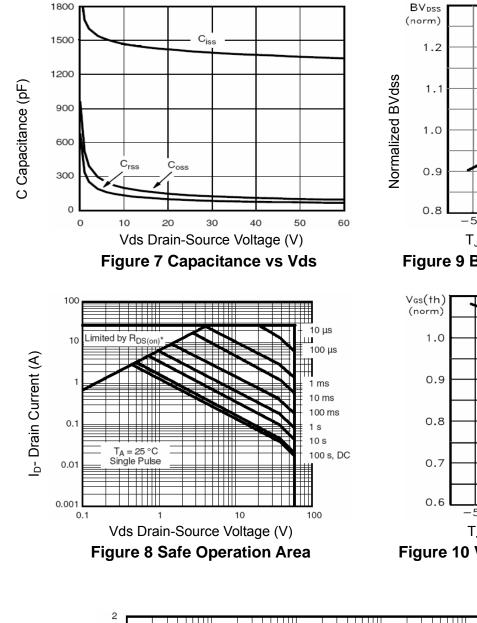
0.8



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NCE603S



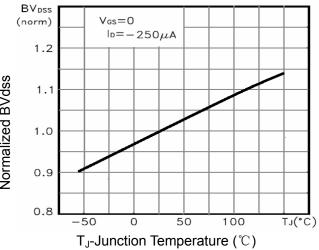


Figure 9 BV_{DSS} vs Junction Temperature

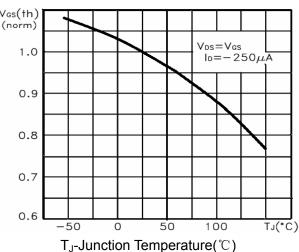
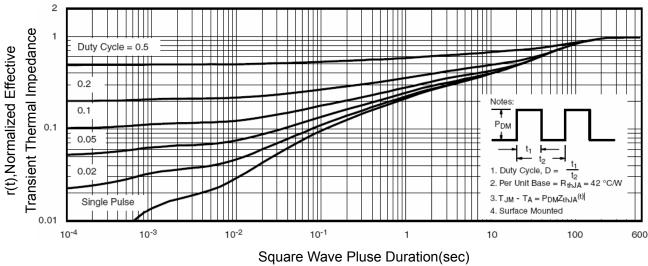


Figure 10 V_{GS(th)} vs Junction Temperature

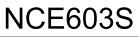




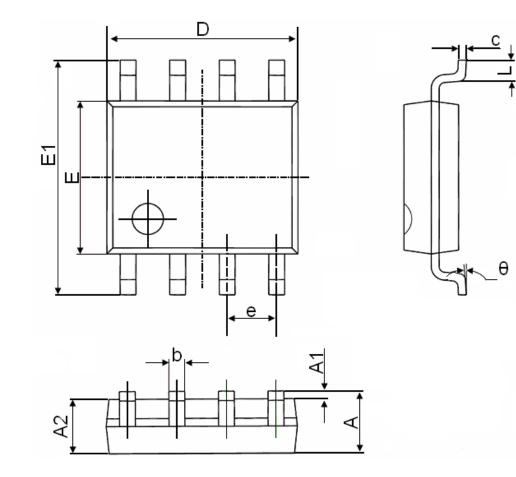


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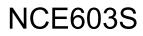
SOP-8 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
e	1.270(BSC)		0.050	(BSC)	
L	0.400	1.270	0.016	0.050	
θ	0 °	8 °	0 °	8°	







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